EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

<table>
<thead>
<tr>
<th>Product Type:</th>
<th>Evaluation Kit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Model Number(s):</td>
<td>EVM430-FR6043</td>
</tr>
</tbody>
</table>

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

EMC Directive 2014/30/EU

The following harmonized standards and technical specifications have been applied:

EN 61326-1:2013

Notified Body:

<table>
<thead>
<tr>
<th>Notified Body:</th>
<th>Intertek Testing &amp; Certification LTD</th>
</tr>
</thead>
<tbody>
<tr>
<td>Notified Body Number</td>
<td>0359</td>
</tr>
<tr>
<td>Reference number of the</td>
<td>0003533</td>
</tr>
<tr>
<td>certificate of notified body</td>
<td></td>
</tr>
</tbody>
</table>

Technical Compliance File Held by:
Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

<table>
<thead>
<tr>
<th>Name:</th>
<th>Darrin Malpass, Customer Quality Engineer</th>
</tr>
</thead>
<tbody>
<tr>
<td>Address:</td>
<td>13905 UNIVERSITY BLVD, SUGAR LAND, TX 77479</td>
</tr>
</tbody>
</table>

_Sugar Land, TX_      _07/24/18_                  
Place of issue        Date of issue                  Signature of Authorized Person
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